IPC ASSOCIATION ELECTRONIC	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights rese international and Pan-American copyright conventions.			All rights reserved un	nder both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility								
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute								eous Materia	rials and Mfg Information			
upplier	r Information													
Company name*			Company un	Company unique ID			Unique ID Authority				Response Date*			
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uthorize	d Representative*	Title - Representative			P	Phone - Representative*				Email - Representative*				
Product-Env-Stewards Pro			Product Env	Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com			
	Requester Item Number	Mfr Iten	n Number	Mfr Item Name			Effective Date	Version	Manufactur	Manufacturing Site		UOM	Unit Type	
		FCPF190N60E SF2 600V 190m		SF2 600V 190mO	hm E TO220F	D220F 2025-05-12		CNP	CNP		mg	Each		
lanufa	cturing Process Inform		Terminal Base	Aller	-STD-020 MSI	Dating	Dools Duo oo	aa Dady Tan	an aratura May Ti	ma at Daals 7	Formanatura Numbe	or of Dofloys Cy	alas	
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	information regarding materia	al composition	nlagge nefer t	n nogo 2										

RoHS Material Composition Declaration			Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, itssuppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and/Conditions of Sale applicable to such part shall apply.										
RoHS Declaration * 4 - Item(s	) does not contain RoHS restricted substance	s per the definition above except for selected exemp	tions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.										
Supplier Digital Signature Ra	astislav Drska	-En								

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	13.5	mg	Supplier	Silicon (Si)	7440-21-3		13.5	mg
Die Attach	4.013	mg	Supplier	Silver (Ag)	7440-22-4		0.0602	mg
			A	Lead (Pb)	7439-92-1	7a	3.7522	mg
			Supplier	Tin (Sn)	7440-31-5		0.2007	mg
Lead Frame	1289.5	mg	Supplier	Silver (Ag)	7440-22-4		2.579	mg
			Supplier	Iron (Fe)	7439-89-6		1.2895	mg
			Supplier	Copper (Cu)	7440-50-8		1285.2446	mg
			Supplier	Phosphorus (P)	7723-14-0		0.3868	mg
Mold Compound	785.0		Supplier	Polymer(phenyl glycidil ether)-co- dicyclopentadiene	119345-05-0		23.55	mg
			Supplier	Proprietary	Proprietary Data		11.775	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		39.25	mg
			Supplier	Carbon Black (C)	1333-86-4		3.925	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		117.75	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		39.25	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		549.5	mg
Plating	13.2	mg	Supplier	Tin (Sn)	7440-31-5		13.2	mg
Wire Bond - Al	2.12	mg	Supplier	Aluminum (Al)	7429-90-5		2.12	mg